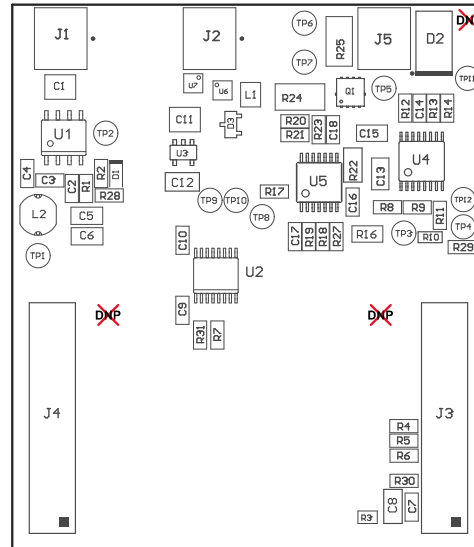
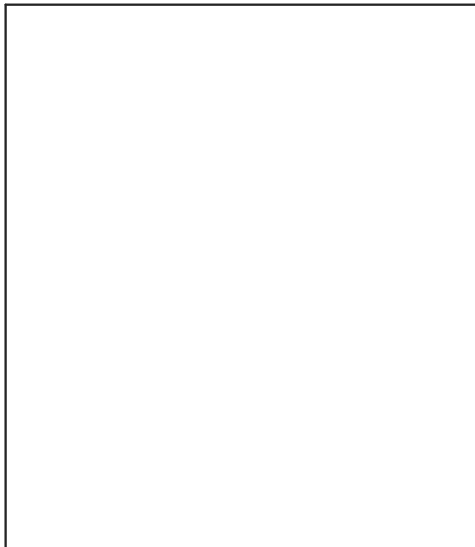


- ZZ1 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- ZZ2 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01621	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M5 Assembly Top	TID #: TIDA-01621		
PLOT NAME = Top Assembly Drawing	GENERATED : 5/8/2018	4:42:26 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01621	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M6 Assembly Bottom	TID #: TIDA-01621		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 5/8/2018	4:42:28 PM	TEXAS INSTRUMENTS

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